

High-fidelity three-dimensional simulations of thermionic energy converters

Nathan Cook^{*&}, Jonathan Edelen[&], Chris Hall[&], Mike Keilman[&],
Paul Moeller[&], Rob Nagler[&], Jean-Luc Vay[#]



*[*ncook@radiasoft.net](mailto:ncook@radiasoft.net)*

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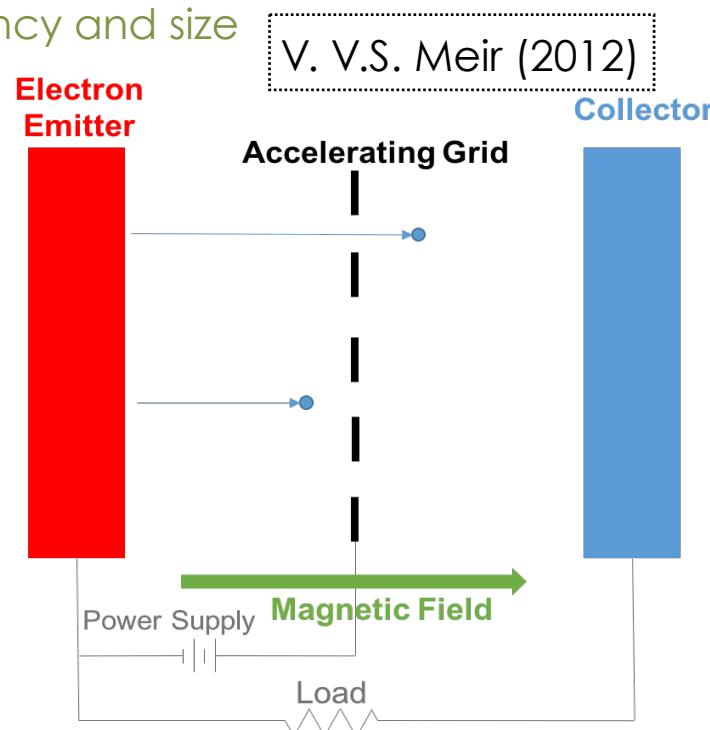
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Thermionic Energy Converters as Alternative Electrical Generators

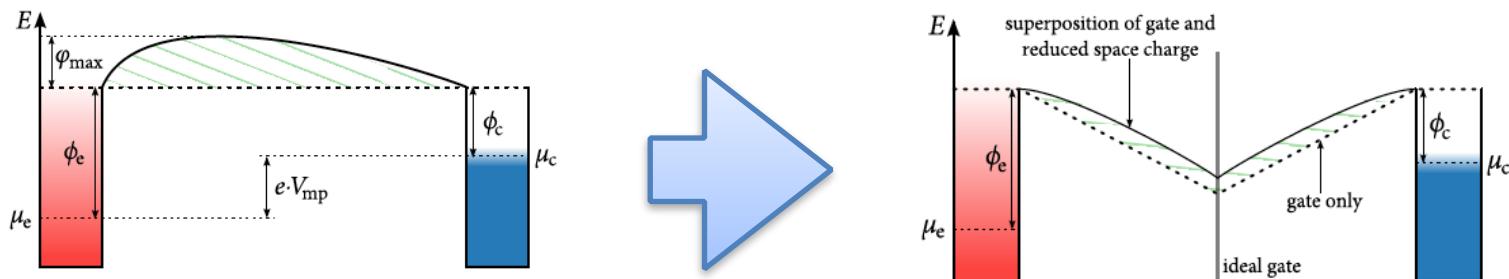
- Electricity generation in the United States (and elsewhere) is largely a product of old technologies
 - Large Scale (>MW): fuel drives turbines to generate current
 - High fixed costs for development and deployment - efficiency at large scale
 - Stagnant industrial progress
 - Small scale (<~KW): lithium-ion batteries
 - High materials cost limits price/stored-energy - not scalable
 - Battery technologies reaching limits on efficiency and size
- Thermionic Energy Converters (TECs)
 - Boil off electrons at hot emitter and absorb at cold collector to generate current.
 - Power is generated by difference in electrochemical potential
- Compelling features of TECs
 - High efficiencies approaching Carnot limit
 - Scalable, robust, no moving parts
 - Challenging to model! Complex dynamics!



TEC constraints and design strategies

- Thermionic emission scales strongly with temperature $j_T = AT^2 e^{-(\phi_w - \Delta\phi)/k_b T}$
- Child-Langmuir limits peak current for simple diode
 - Lower temperature leads to reduced current
 - Biasing anode leads to lower efficiency
 - Reducing gap leads to cooling difficulties
- Solution: Inter-gap grid applies voltage

$$j_{CL} = \epsilon_0 \sqrt{\frac{2e}{m}} \frac{V^{3/2}}{d^2}$$



- Increase effective space-charge limit without biasing anode
- Grid is lossy. Its design and placement must be optimized

Realistic TEC efficiency includes loss channels

- Goal: Maximize current at collector, minimize losses

$$\eta = \frac{P_{\text{load}} - P_{\text{grid}}}{P_{\text{ec}} + P_{\text{R}} + P_{\text{ew}}}$$

- Many possible energy loss channels during operation

1. Kinetic losses - excess electron kinetic energy heats surface

$$P_{\text{ec}} = J_{\text{e}} (\phi_{\text{e}} + 2k_{\text{B}}T_{\text{e}}) - tJ_{\text{c}} (\phi_{\text{e}} + 2k_{\text{B}}T_{\text{c}})$$

2. Grid losses - electron intercepted by accelerating gate

$$P_{\text{grid}} = V_{\text{grid}} (J_{\text{grid}} + tJ_{\text{c}})$$

3. Radiative losses - heat lost through emissivity

$$P_{\text{R}} = \epsilon\sigma_{\text{sb}} (T_{\text{e}}^4 - T_{\text{c}}^4)$$

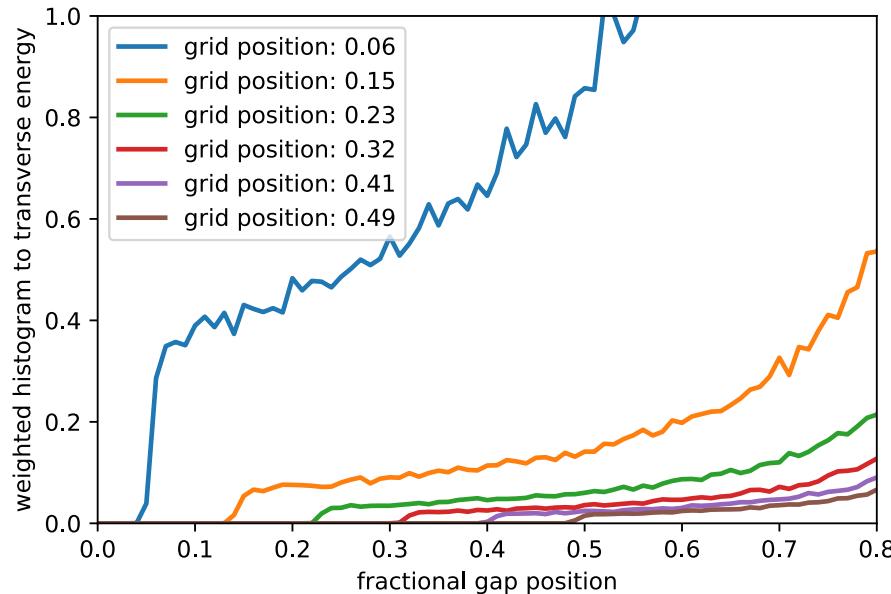
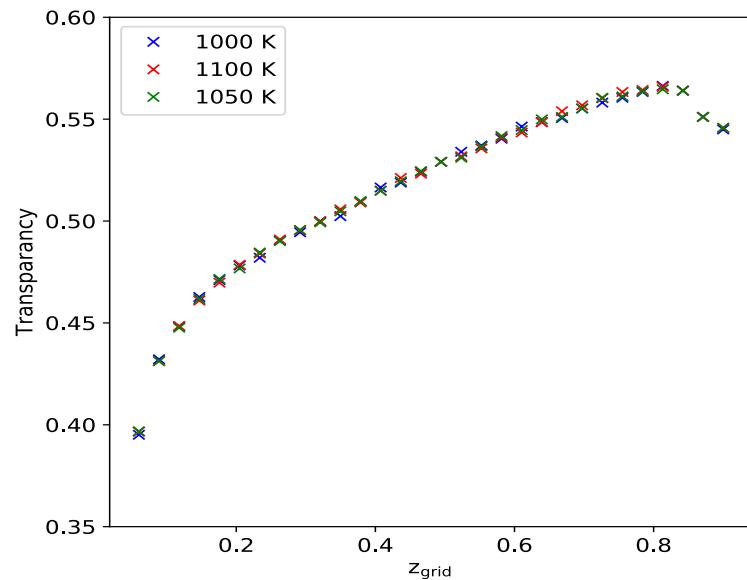
4. Resistive losses - losses in external circuit

$$P_{\text{ew}} = 0.5 \left(\frac{L}{\rho_{\text{ew}}} (T_{\text{em}} - T_{\text{env}})^2 - \rho_{\text{ew}} (J_{\text{ec}} - tJ_{\text{c}})^2 \right)$$

For more on these models, see Voesch et al. *Energy Technology*, 5(12):2234-2243, (2017).

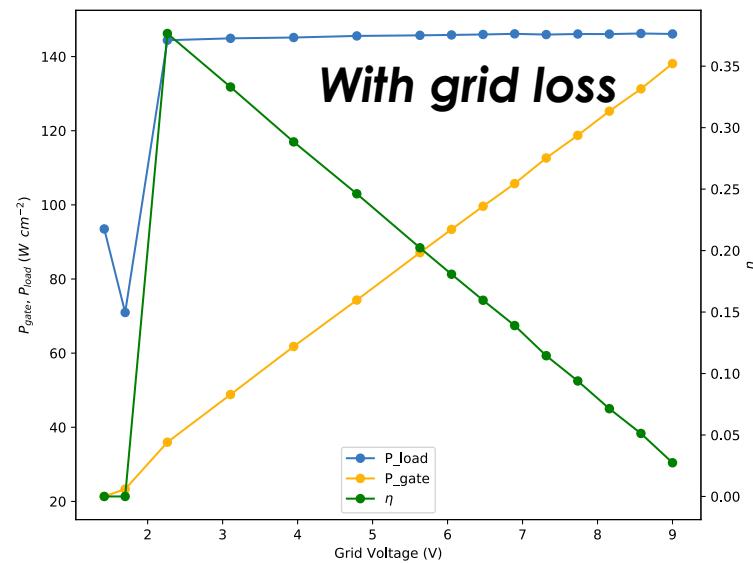
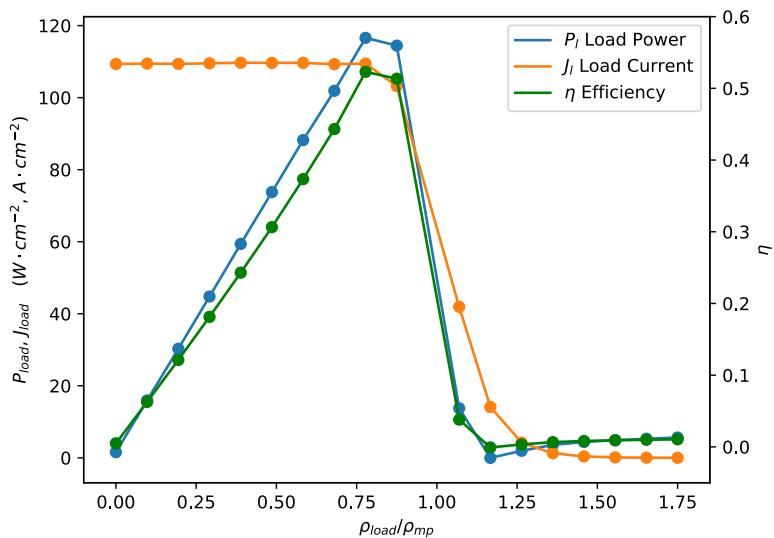
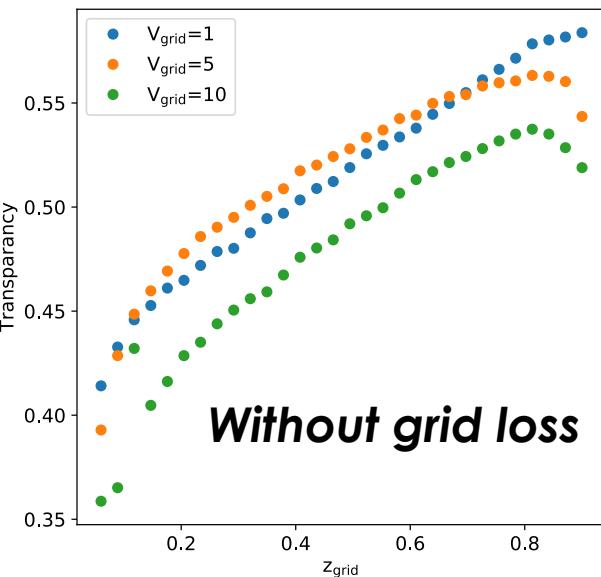
Case Study: Grid transparency in relation to transverse dynamics

- For simple device, transparency peaks as grid approaches collector, even for different T_e and V_{grid}
 - Transverse kick from grid drives large oscillations
 - Effects of transverse motion mitigated closer to grid
 - This effect is dimensional in nature, coupling motion in both planes
 - Further reason why 3D dynamics are critical to optimizing
- Conclusion:** Minimize transverse dynamics for maximum efficiency



Case Study: Grid losses shift ideal operating point

- Ignoring grid losses, efficiency scales consistent across different voltages
- Introducing grid/anode losses significantly changes optimum
 - Losses scale strongly with voltage
 - But, grid voltage is important for extracting ideal current
- **Conclusion:** Voltage must optimize total current while minimizing energy-per-particle
 - Similar to an I-V characteristic



Improvements in modeling TECs using the Warp Code

- An open-source* plasma and accelerator simulation framework, developed by Lawrence Berkeley National Laboratory, now a part of the Berkeley Lab Accelerator Simulation Toolkit
 - 2D, R-Z, and 3D geometries featuring electrostatic and electromagnetic particle-in-cell
 - Macro-particle, Multi-species, beam-envelope, transverse slice, emission models
 - Internal conductors, dielectrics, adaptive mesh refinement
 - RadiaSoft efforts to support vacuum devices[#]:
 - Enhance dielectric capabilities and extend solver to 3D and parallel use
 - Improve and validate emission models for novel cathodes
 - New geometry capabilities (mesh-refinement/“cut-cells” with internal boundaries)
 - CAD input-output with support for standard files

* <https://bitbucket.org/berkeleylab/warp/src/master/>

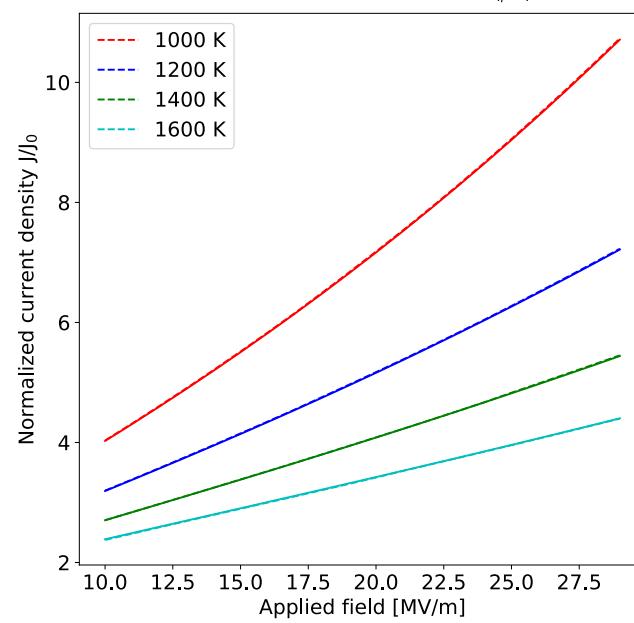
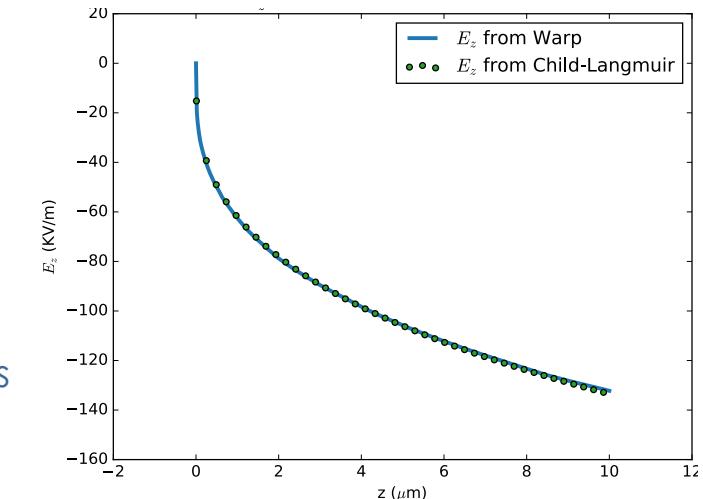
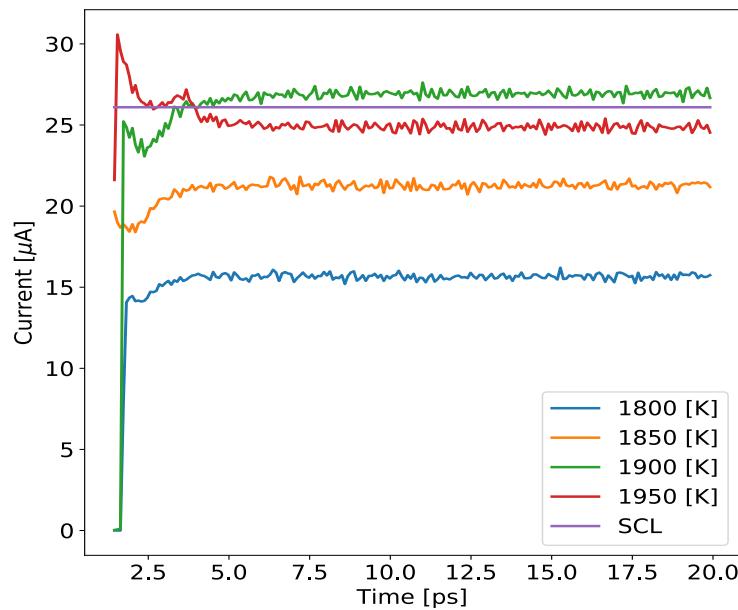
& <http://blast.lbl.gov/blast-codes-warp/>

<https://bitbucket.org/radiasoft/warp/src/master/>

Additional developments for plasma dynamics at Exascale - R. Ryne 10/21

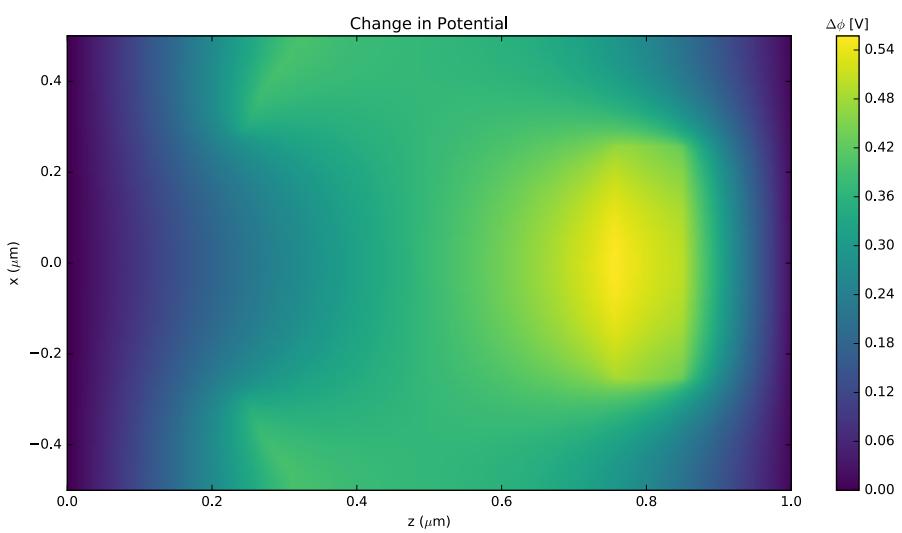
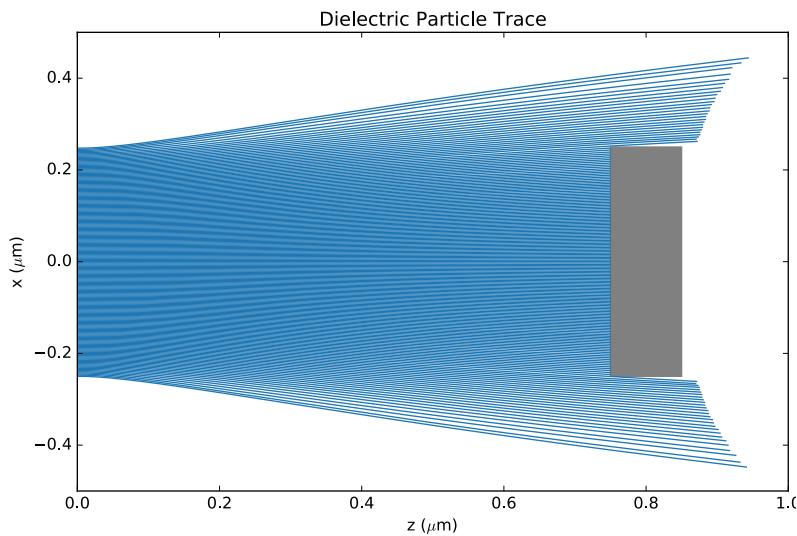
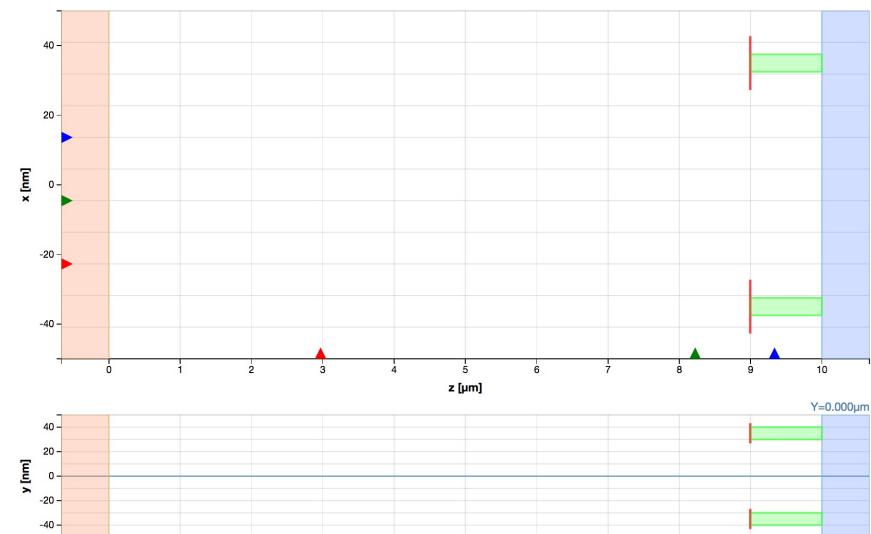
Requirements: Emission in the space-charge limited regime

- TECs are most efficient when space-charge limited
 - Child-Langmuir is a cold limit
 - Approaching C-L at high temperature introduces some transient effects which quickly dampen
- Proper modeling of field enhancement, “Schottky emission” is required due to applied field
 - Field enhancement is critical for advanced emitters
 - Warp implementation shows good agreement



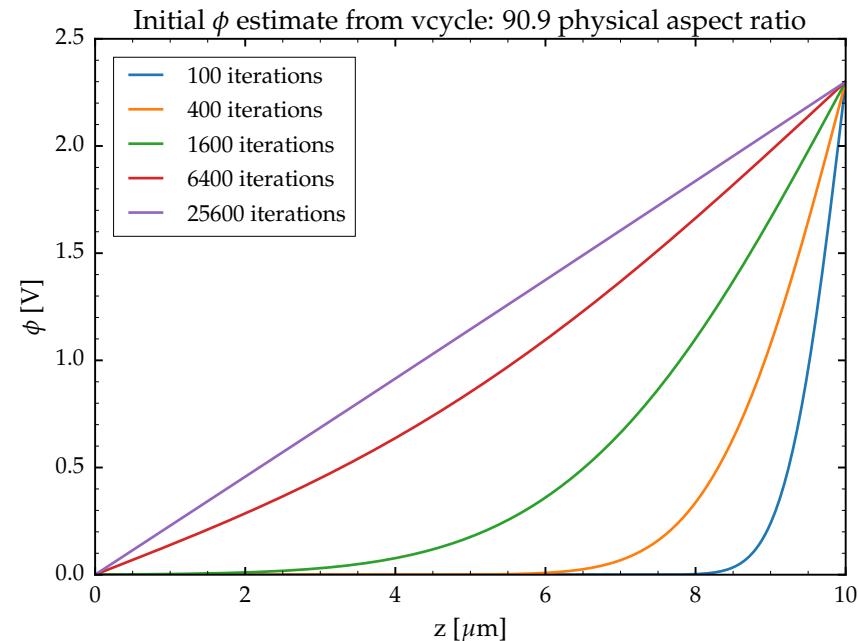
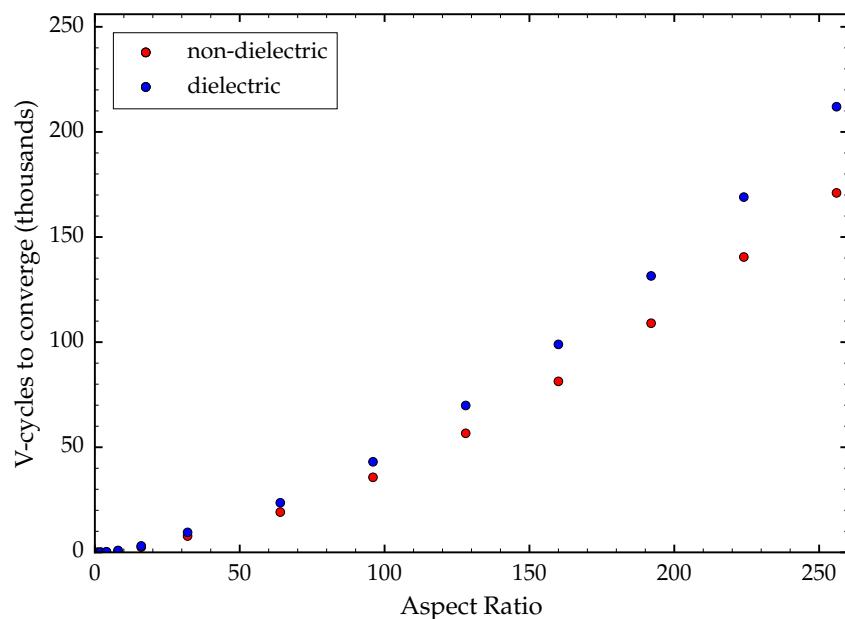
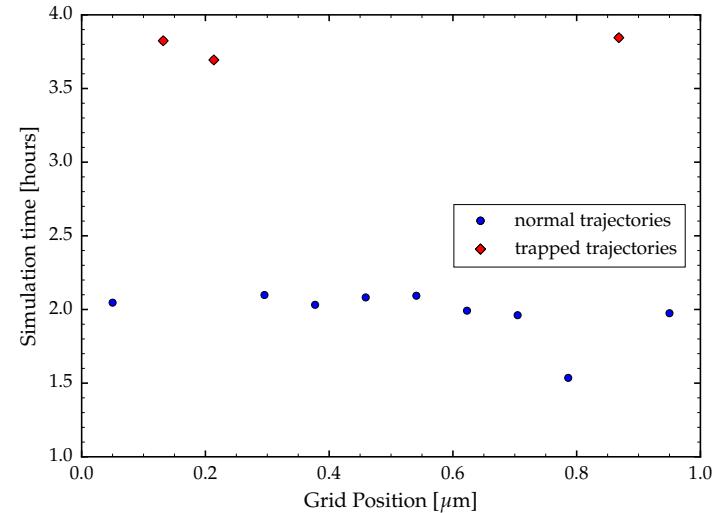
Requirements: Self-consistent dielectric interactions

- TEC grids may require dielectric supports or anchors for mechanical stability
 - Isolated from an external circuit, these supports may charge and deflect particles
- Improvements to Warp's capabilities
 - Extended MultiGridDielectric solver from 2D to 3D, parallelization
 - Installing dielectrics is now consistent with installing conductors
 - New “Dielectric Particles” permit charging of dielectric surfaces



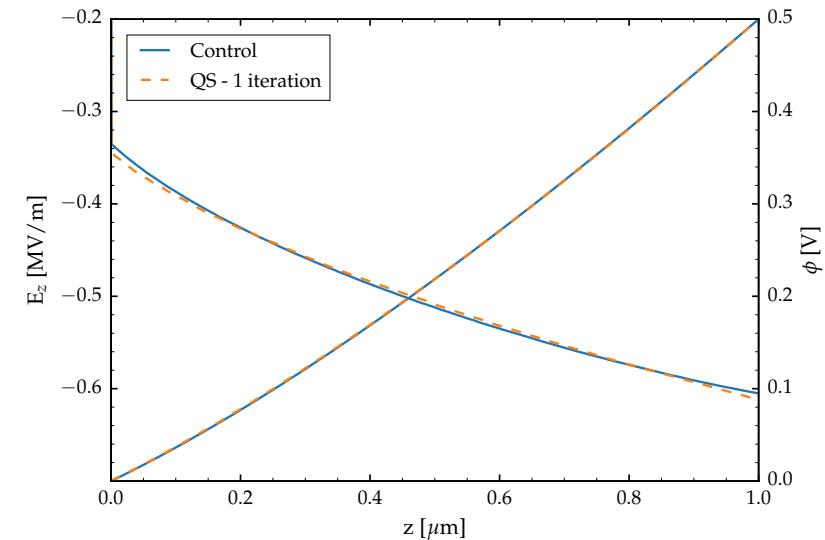
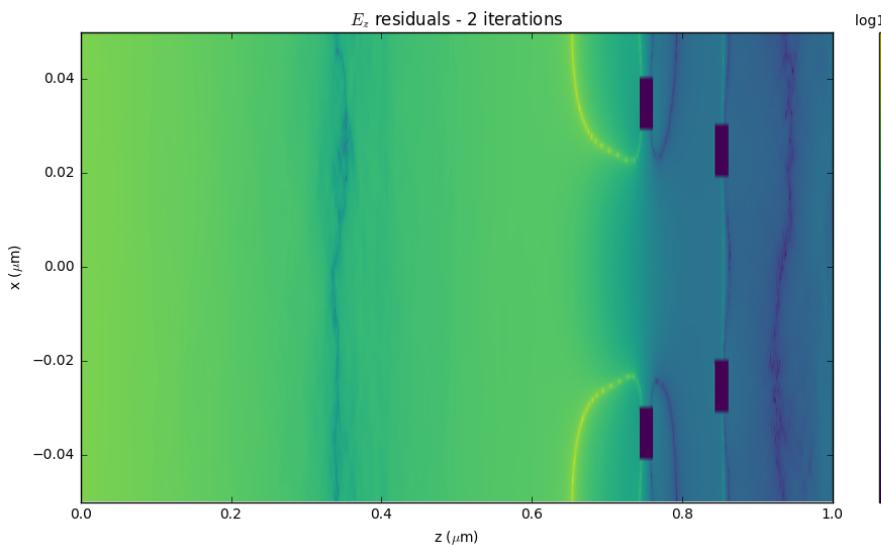
Challenges: Reducing computational expense

- Most of a TEC is empty space
 - Areas of interest are separated by vacuum region
 - Transit time between these areas of interest is significant fraction of simulation
 - Reflection and oscillatory dynamics introduce transient behavior extends simulation duration
- High aspect ratio limits solver speed
 - Cell-centered dielectric solver is slower as coarseness of V-cycle is limited by extra cells



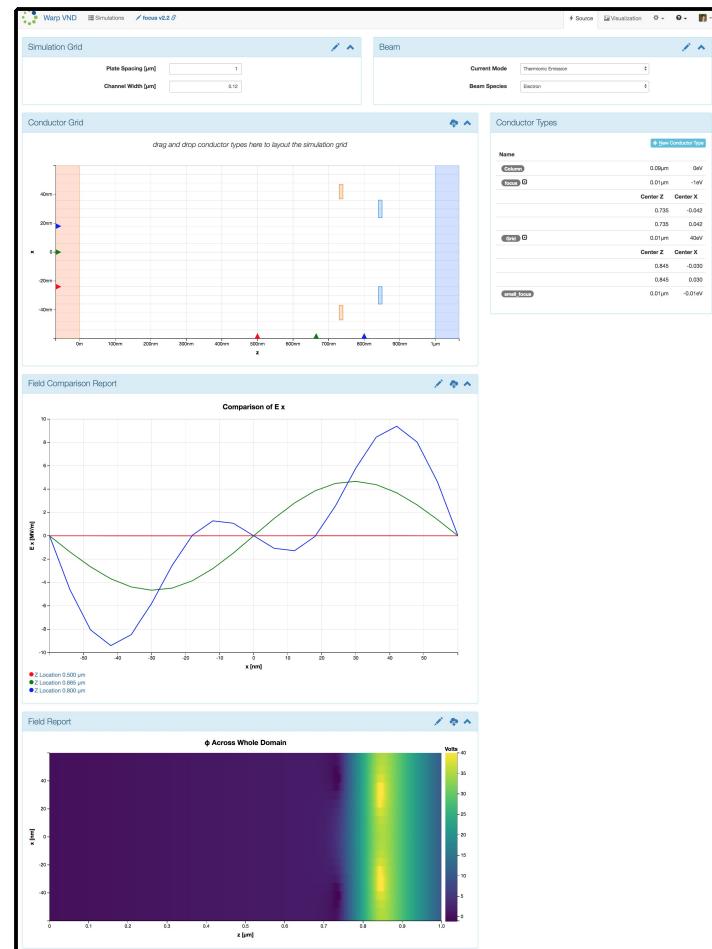
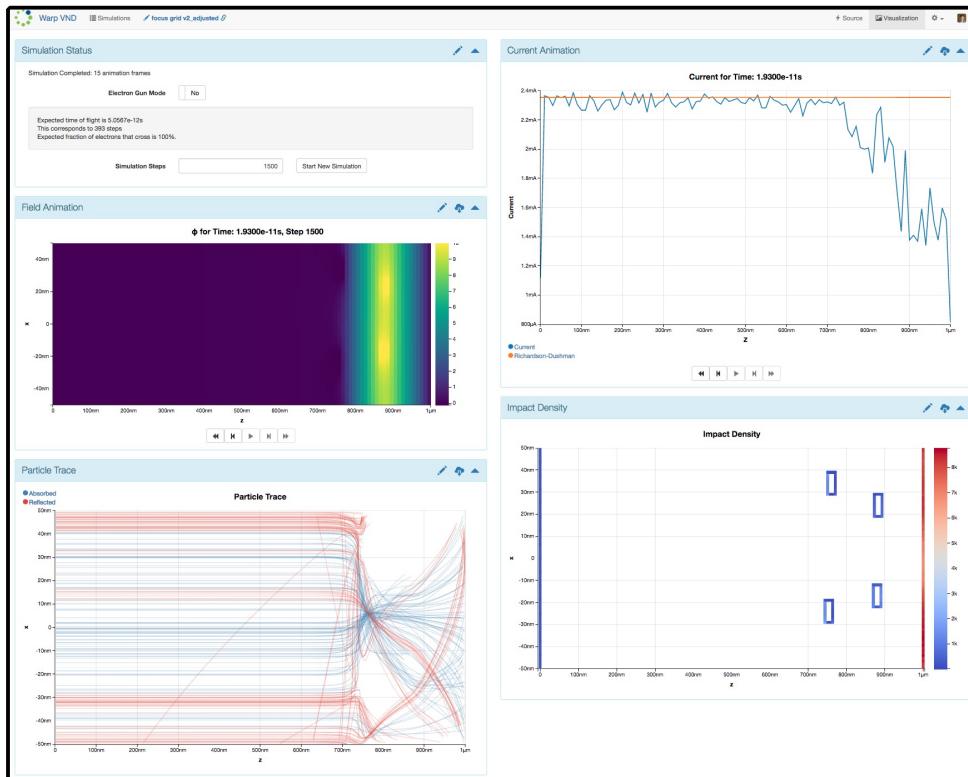
A hybrid quasi-static approach to reduce computational demands

- Achieving steady-state drains significant resources (25-30% of total)
 - Especially significant for 3D simulations with small grid features and small time-step
- Use quasi-static solver: iterative emission converges to steady-state solution much faster!
 - Successful strategy for gun/source studies with clearly defined geometries
 - Efficient when current is evenly distributed, less efficient for sharp bottlenecks in current
 - Still suffers from captured trajectory problem
- Planned improvements:
 - Parallelization for future efforts with 3D optimization
 - Resolve captured trajectories through smart “time-out”

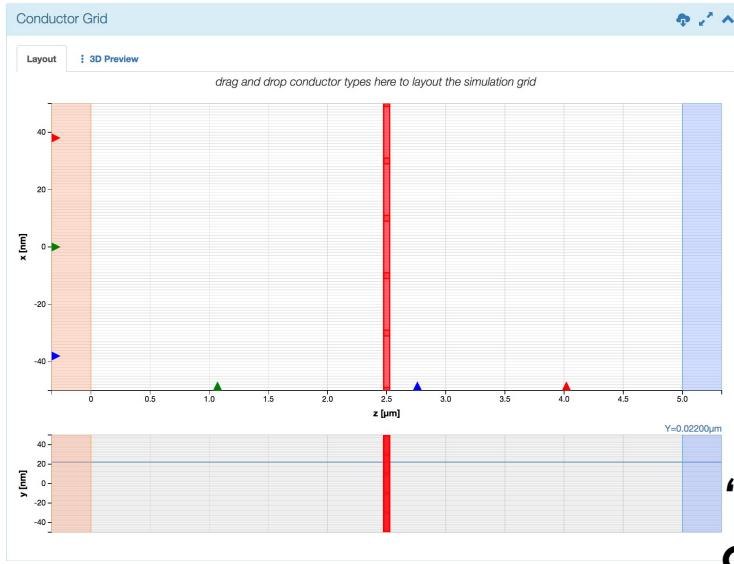


A cloud-based platform for VNDs via Sirepo

- Complex simulation tools require expertise and dedicated support for training and troubleshooting
- We are developing a 3D interface on RadiaSoft's Sirepo platform - <https://alpha.sirepo.com/#/warpvnd>
- Automated Diagnostics - fields, particles, loss diagrams
- Choice of Solvers - multigrid, dielectric, quasi-static
- Automated Visualizations - 2D/3D rendering with VTK.js



Streamlining TEC designs in Sirepo

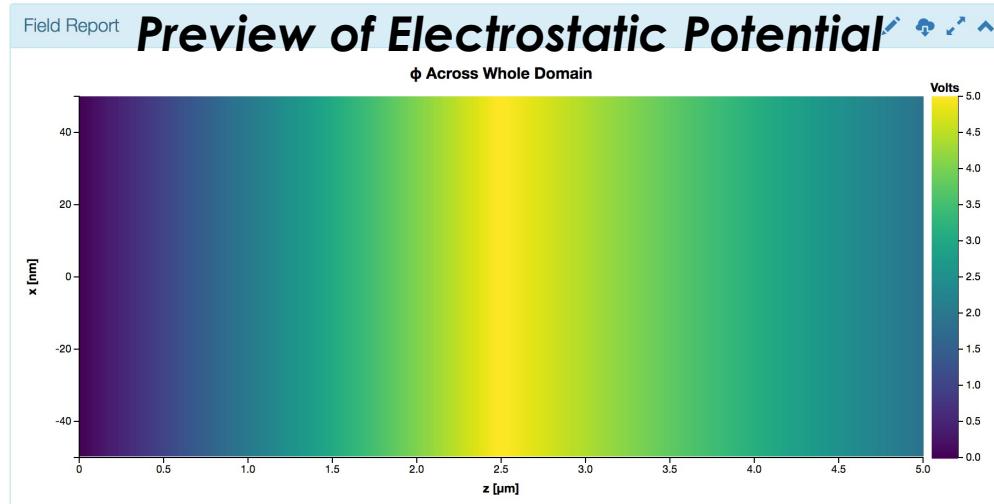
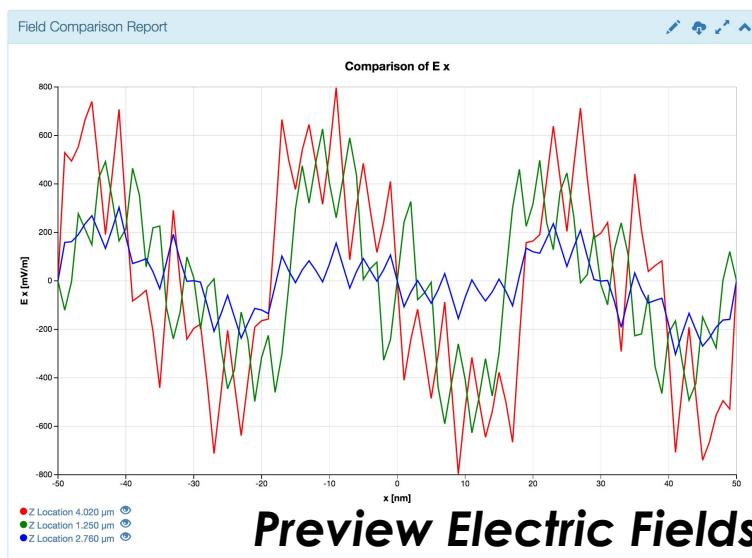
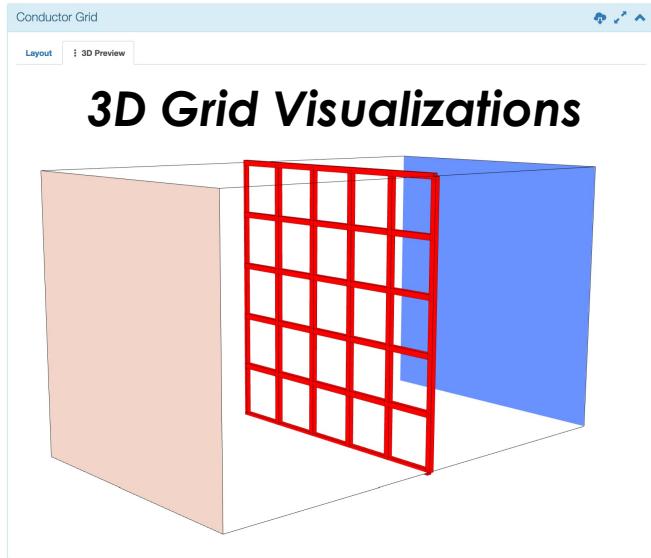


Conductor Types

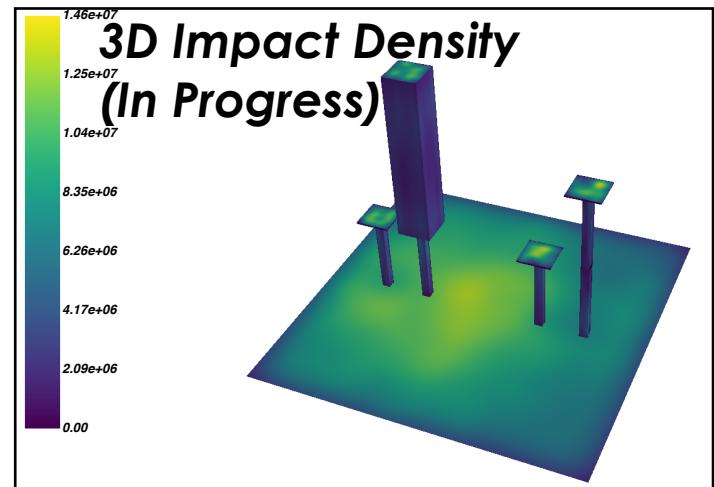
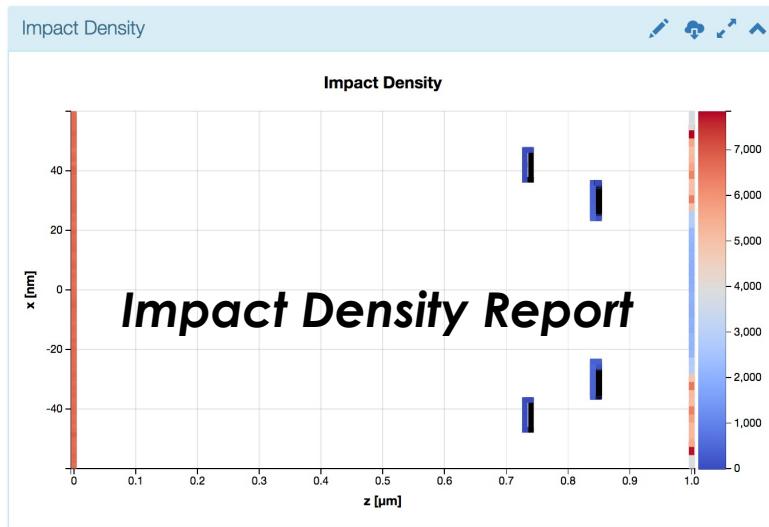
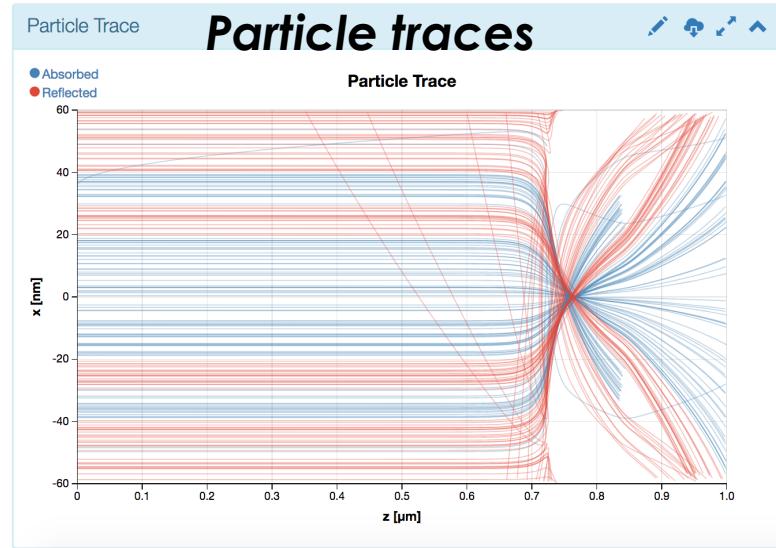
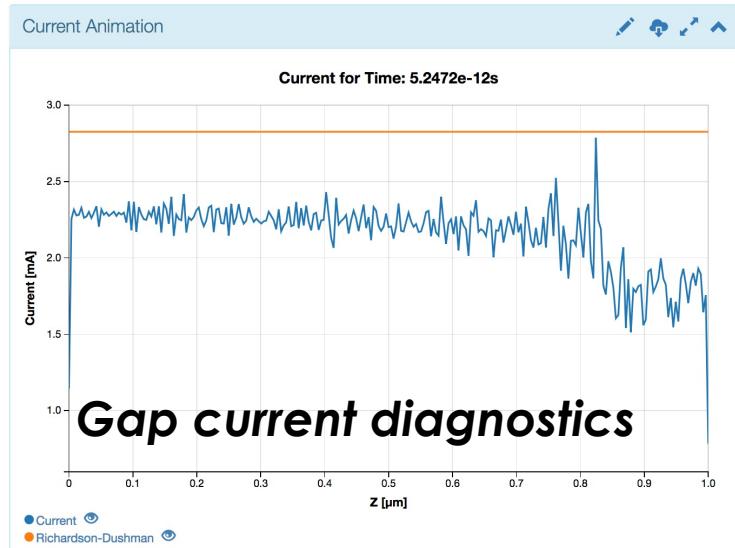
+ New Conductor Type

Name	0.05μm	5eV	
grid_H	Center Y	Center Z	Center X
	0	2.500	-0.050
	0	2.500	-0.030
	0	2.500	-0.010
	0	2.500	0.010
	0	2.500	0.030
	0	2.500	0.050
grid_V	0.05μm	5eV	
	Center Y	Center Z	Center X
	-0.010	2.500	0
	0.010	2.500	0
	0.030	2.500	0
	-0.030	2.500	0
	0.050	2.500	0
	-0.050	2.500	0.000

“Drag and drop”
grid design

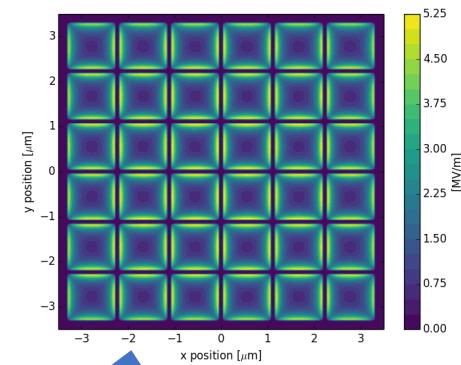
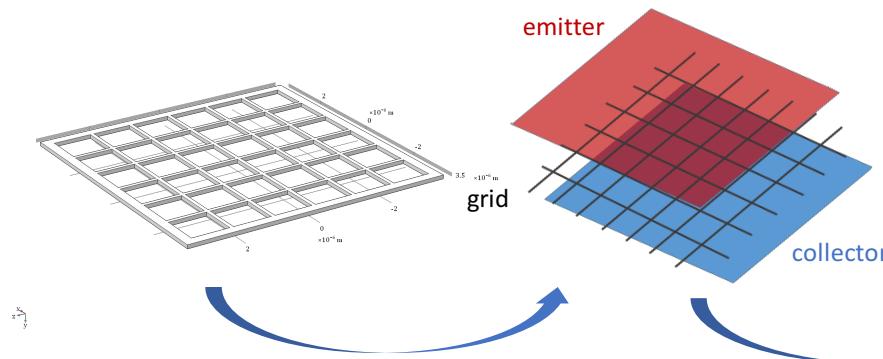


Rapid design evaluation in Sirepo

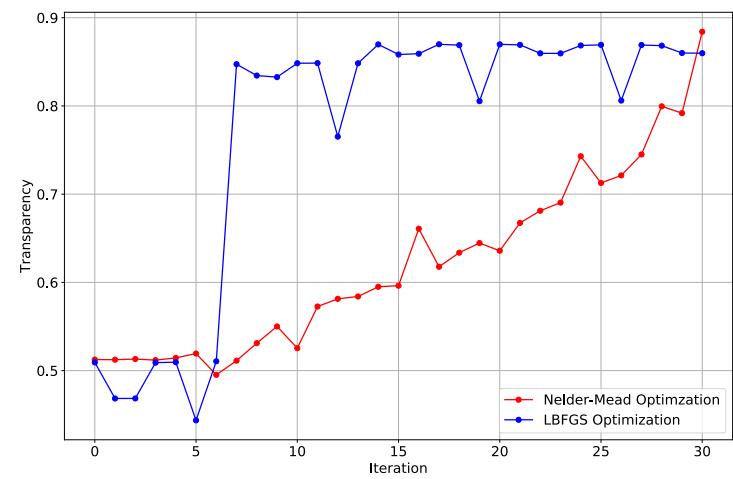


Future Interface Plans

- Generalized CAD support
 - Leverage cut-cells/mesh refinement
 - Vertex-based specification
 - STL I/O



- Launching of jobs at NERSC
 - NEWT (NERSC Web Toolkit) for queue management and authentication
 - Shifter for container management
- Integrate and improve optimization
 - Native Warp with Python hooks
 - Standard Scikit + genetic algorithms



Conclusions

- Thermionic energy converters present attractive solutions for efficiency energy production
 - Scalable from personal (KW) to community (MW) sources
 - Novel emitter technologies promise higher efficiency
 - Novel production techniques promise portability
- Optimization of these devices requires careful simulation studies
 - Proper measurement of steady-state system
 - Rigorous efficiency model to capture discrete loss channels
- Using Warp, we are improving the capabilities to model and optimize TECs and similar nano-electronics
 - Enhanced dielectric solver for realistic structures
 - Improved geometry-handling for complex emitters/grids
 - New optimization tools for deploying Warp simulations
- These tools are being made available via a browser-based platform for scientific computing, <https://www.sirepo.com>

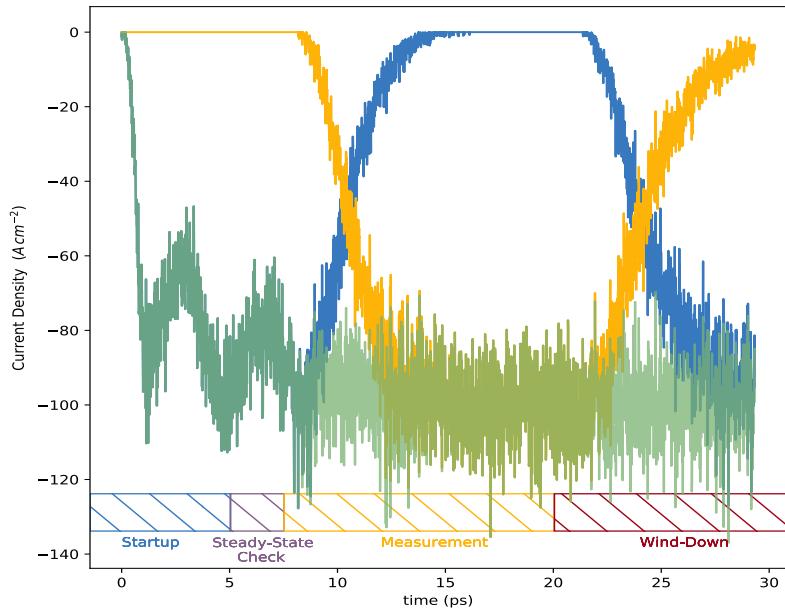
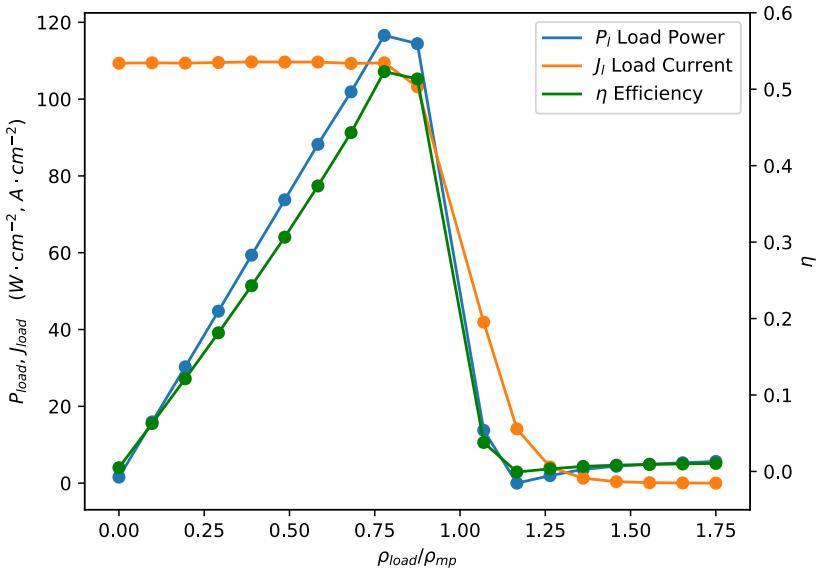
Additional material

Anatomy of a TEC Simulation

Four Stages of Simulation

- **Startup:** Begin emission
- **Steady-state check:** Validate current
- **Measurement:** Begin collection
- **Wind-Down:** End collection

Required statistics are device specific!



External circuit model required to maintain feedback

- V_{load} must bridge gap in work functions
- The load resistance must be chosen based on the operating conditions
- If σ is too small, low voltage
- If σ is too large, low current